



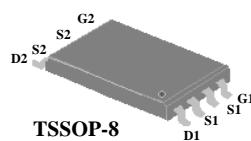
▼ Low On-resistance

▼ Capable of 2.5V Gate Drive

▼ Low Drive Current

▼ Surface Mount Package

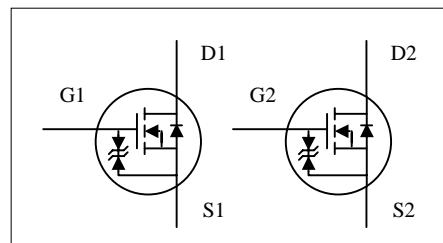
▼ RoHS Compliant & Halogen-Free



BV_{DSS}	20V
$R_{DS(ON)}$	28mΩ
I_D	4.6A

Description

Advanced Power MOSFETs from APEC provide the designer with the best combination of fast switching, ruggedized device design, ultra low on-resistance and cost-effectiveness.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	20	V
V_{GS}	Gate-Source Voltage	± 12	V
$I_D @ T_A = 25^\circ C$	Continuous Drain Current ³	4.6	A
$I_D @ T_A = 70^\circ C$	Continuous Drain Current ³	3.7	A
I_{DM}	Pulsed Drain Current ¹	20	A
$P_D @ T_A = 25^\circ C$	Total Power Dissipation	1	W
	Linear Derating Factor	0.008	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Value	Unit
R_{thj-a}	Maximum Thermal Resistance, Junction-ambient ³	125	°C/W



Electrical Characteristics@ $T_j=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	20	-	-	V
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance ²	$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=4\text{A}$	-	-	28	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_{\text{D}}=2\text{A}$	-	-	40	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	0.5	-	-	V
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=4.6\text{A}$	-	9.7	-	S
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	uA
	Drain-Source Leakage Current ($T_j=70^\circ\text{C}$)	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$	-	-	25	uA
I_{GSS}	Gate-Source Leakage	$V_{\text{GS}}=\pm 10\text{ V}, V_{\text{DS}}=0\text{V}$	-	-	± 10	uA
Q_g	Total Gate Charge	$I_{\text{D}}=4.6\text{A}$	-	12.5	-	nC
Q_{gs}	Gate-Source Charge	$V_{\text{DS}}=20\text{V}$	-	1	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge		-	6.5	-	nC
$t_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DS}}=10\text{V}$	-	5	-	ns
t_r	Rise Time	$I_{\text{D}}=1\text{A}$	-	9	-	ns
$t_{\text{d}(\text{off})}$	Turn-off Delay Time		-	26.2	-	ns
t_f	Fall Time	$V_{\text{GS}}=5\text{V}$	-	6.8	-	ns
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$	-	355	-	pF
C_{oss}	Output Capacitance		-	190	-	pF
C_{rss}	Reverse Transfer Capacitance	$f=1.0\text{MHz}$	-	85	-	pF

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
I_s	Continuous Source Current (Body Diode)	$V_D=V_G=0\text{V}, V_S=1.2\text{V}$	-	-	0.83	A
V_{SD}	Forward On Voltage ²	$T_j=25^\circ\text{C}, I_s=1.25\text{A}, V_{\text{GS}}=0\text{V}$	-	-	1.2	V

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Surface mounted on 1 in² copper pad of FR4 board ; 208°C/W when mounted on Min. copper pad.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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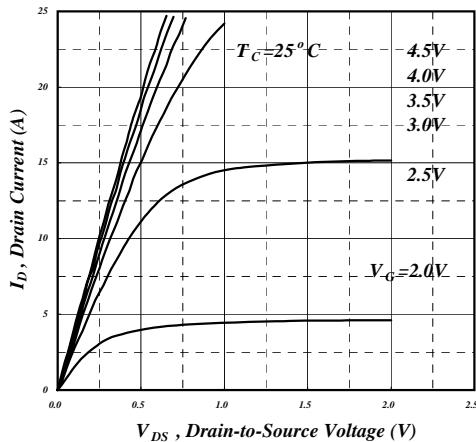


Fig 1. Typical Output Characteristics

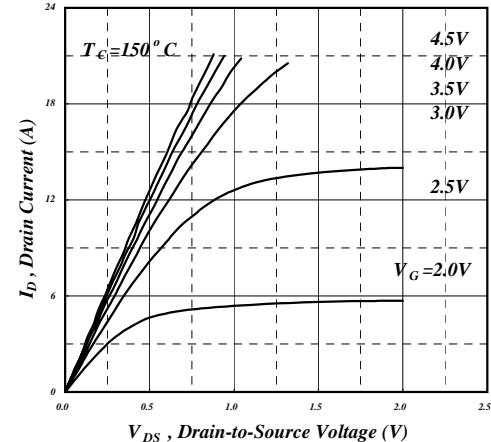


Fig 2. Typical Output Characteristics

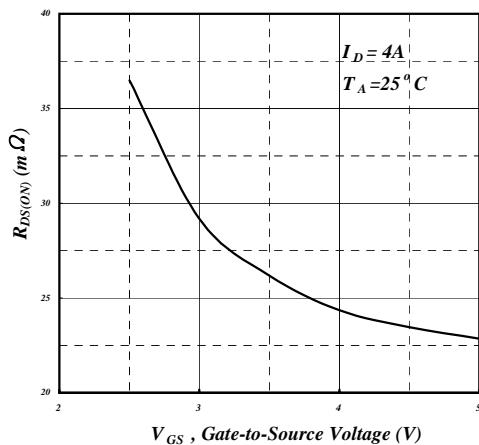


Fig 3. On-Resistance v.s. Gate Voltage

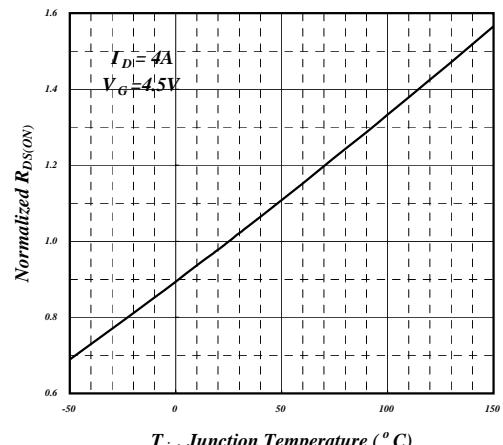


Fig 4. Normalized On-Resistance

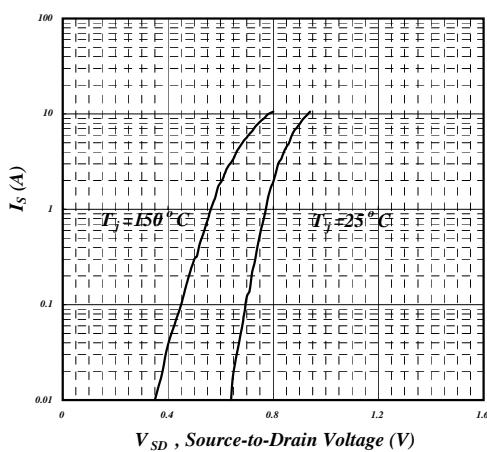


Fig 5. Forward Characteristic of Reverse Diode

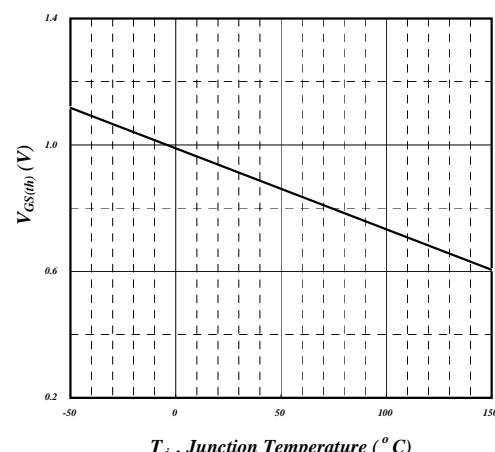


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

AP9926GEO-HF

